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CONFIRMATION NO. 7420

SERIAL NUMBER 10/772,311	FILING or 371(c) DATE 02/06/2004 RULE	CLASS 264	GROUP ART UNIT 1791	ATTORNEY DOCKET NO. 2557-000220/US		
APPLICANTS Sang-Hyeop Lee, Cheonan-si, KOREA, REPUBLIC OF; Hee-Kook Choi, Cheonan-si, KOREA, REPUBLIC OF; Cheol-Joon Yoo, Cheonan-si, KOREA, REPUBLIC OF; ** CONTINUING DATA ***** ** FOREIGN APPLICATIONS ***** REPUBLIC OF KOREA 2003-9361 02/14/2003 REPUBLIC OF KOREA 2003-31152 05/16/2003 ** IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** 05/05/2004						
Foreign Priority claimed <input checked="" type="checkbox"/> Yes <input type="checkbox"/> No 35 USC 119(a-d) conditions met <input checked="" type="checkbox"/> Yes <input type="checkbox"/> No Verified and Acknowledged <u>/EDMUND H LEE/</u> Examiner's Signature		<input type="checkbox"/> Met after Allowance Initials	STATE OR COUNTRY KOREA, REPUBLIC OF	SHEETS DRAWINGS 6	TOTAL CLAIMS 16	INDEPENDENT CLAIMS 3
ADDRESS HARNESS, DICKEY & PIERCE, P.L.C. P.O. BOX 8910 RESTON, VA 20195 UNITED STATES						
TITLE MOLDING METHOD FOR ENCAPSULATING BOTH SIDES OF PCB MODULE WITH WAFER LEVEL PACKAGE MOUNTED PCB						
FILING FEE RECEIVED 770	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:			<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees (Filing) <input type="checkbox"/> 1.17 Fees (Processing Ext. of time) <input type="checkbox"/> 1.18 Fees (Issue) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit		